

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
THOMAS BUETTNER	11/05/2014
MARKUS SIPTROTH	10/30/2014
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<b>Postal Code:</b>	70469
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14191934
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<b>ATTORNEY DOCKET NUMBER:</b>	2327-0001
<b>NAME OF SUBMITTER:</b>	DAVID RICHARD MOORMAN
<b>SIGNATURE:</b>	/David Richard Moorman/
<b>DATE SIGNED:</b>	04/15/2015
<b>Total Attachments: 4</b>	
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ASSIGNMENT

Pursuant to our obligation to Robert Bosch GmbH (hereinafter referred to as "Assignee"), a German corporation having a mailing address at:

Postfach 30 02 20		Wernerstr. 1
70442 Stuttgart	and	70469 Stuttgart
GERMANY		GERMANY

and for other valuable and sufficient consideration, receipt whereof is hereby acknowledged, we:

Thomas Buettner  
Doebereinerstrasse 33  
07745 Jena  
Germany

Markus Siptroth  
Strasse Der Freundschaft 68  
99326 Dienstedt  
Germany

confirm our obligation to and hereby sell, assign and convey, unto Assignee, its successors and assigns, except as set forth below, our entire right, title and interest -

(1) in and to an invention entitled "Frame for a Solar Module" for which we have executed a United States patent application, said United States application being assigned U.S. Serial No. 14/191,934 filed on February 27, 2014 and which is disclosed in German Patent Application No. 10 2013 203 412.1, filed on February 28, 2013;

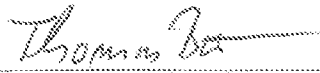
(2) in and to said United States patent application, in and to all other patent applications (including divisional, continuation, continuation-in-part, §111(b) provisional, §111(a), reissue applications, and international patent applications designating the United States) based upon said invention, and in and to the patent or

patents to be granted thereon, including reissues thereof, if any, to the full end of the term or terms for which said patent or patents may be granted; and

(3) in and to all patent applications on said invention now or hereafter filed in countries foreign to the United States of America, including patent applications filed under the Patent Cooperation Treaty, the European Patent Convention or any other international treaty, and including the right to claim priority of said United States application, and in and to any and all patents granted on said applications to the full end of the terms for which said patents may be granted.

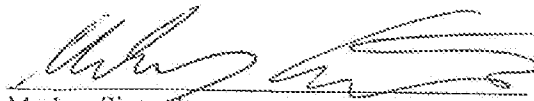
We hereby agree that we will, upon demand of Assignee, its successors or assigns, and without further consideration to us, execute any and all papers that may be necessary, or deemed by Assignee, its successors or assigns, to be necessary, to a complete fulfillment of the intent and purposes of this Assignment, it being understood that any expense incident to the execution of such papers shall be paid by Assignee, its successors and assigns, and not by us.

MMS Docket No. 2327-0001  
Bosch Reference: R.342077

  
Thomas Buettner

Date 05.11.2014

MMB Docket No. 2327-0001  
Bosch Reference: R.348077

  
Date 30.12.2014

Markus Siptroth